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ATAIT

International Symposium on Advanced Technologies and Applications in the Internet of Things

April 12-14, 2018, Osaka, Japan.

The 2018 International Symposium on Advanced Technologies and Applications in the Internet of Things (ATAIT 2018) will be held in Osaka, Japan on April 12-14, 2018. This conference is sponsored by the VLSI center of Ritsumeikan University, Central South University, and supported by IEEE CEDA All Japan Joint Chapter. It provides an international forum for professionals, academics, and researchers to present latest developments in IoT technologies and applications including the network, security, processor architecture, high performance computing, image processing, FPGAs and GPUs, etc. It particularly welcomes those emerging methodologies and techniques which bridge theoretical studies and applications in the Internet of Things. Novel quantitative engineering and science studies may be considered as well. Papers are solicited on all aspects of research and application, including but not limited to:

- Network and security in Internet of Things
- Processor architecture in Internet of Things
- High performance computing in Internet of Things
- FPGAs and GPUs in Internet of Things
- Embedded software in Internet of Things
- Image processing and pattern recognition in Internet of Things
- Bigdata, data analysis and machine learning in Internet of Things
- AI and Robotics in Internet of Things
- Innovation management and Internet of Things

Important Deadlines

Deadline for submission:	February 10th, 2018	February 28th, 2018
Notification of acceptance:	February 28th, 2018	March 10th, 2018
Submission of camera-ready copy:	March 10th, 2018	March 20th, 2018

Contact Address

ATAIT 2018 Conference Secretariat
Ritsumeikan University, 1-1-1, Nojihigashi, Shiga, Japan.
Tel/Fax: +81-XX-XXXX E-mail: atait18@gst.ritsumei.ac.jp

Website: <http://www.hpc.se.ritsumei.ac.jp/~meng/ATAIT2018/>



